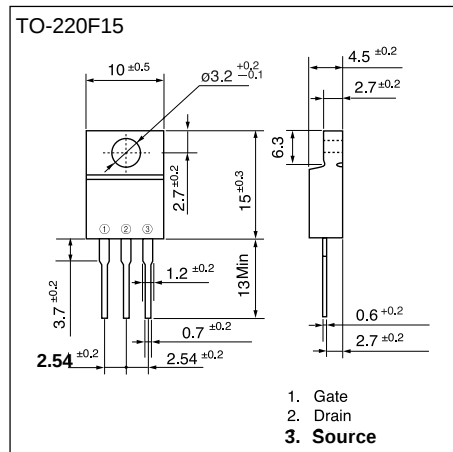


N-CHANNEL SILICON POWER MOS-FET**■ Features**

High speed switching
 Low on-resistance
 No secondary breakdown
 Low driving power
 Avalanche-proof

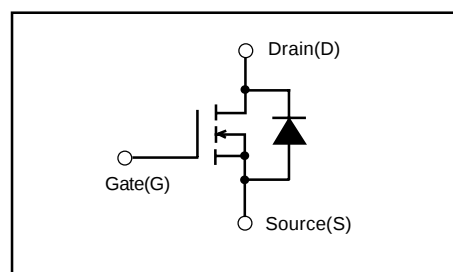
■ Applications

Switching regulators
 UPS (Uninterruptible Power Supply)
 DC-DC converters

**■ Maximum ratings and characteristic Absolute maximum ratings****● (Tc=25°C unless otherwise specified)**

Item	Symbol	Rating	Unit
Drain-source voltage	V_{DS}	100	V
Continuous drain current	I_D	±50	A
Pulsed drain current	$I_{D(puls)}$	±200	A
Gate-source voltage	V_{GS}	±30	V
Maximum Avalanche Energy	E_{AV}^{*1}	464	mJ
Max. power dissipation	$T_a=25^{\circ}C$ P_D	2.0	W
	$T_c=25^{\circ}C$ P_D	70	W
Operating and storage temperature range	T_{ch}	+150	°C
	T_{stg}	-55 to +150	°C

*1 L=298μH, Vcc=24V

■ Equivalent circuit schematic**● Electrical characteristics (Tc =25°C unless otherwise specified)**

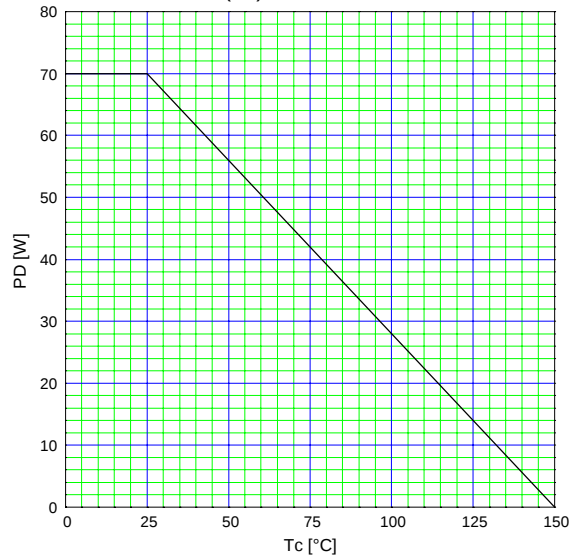
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D=1mA$ $V_{GS}=0V$	100			V
Gate threshold voltage	$V_{GS(th)}$	$I_D=1mA$ $V_{DS}=V_{GS}$	2.5	3.0	3.5	V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=100V$ $V_{GS}=0V$ $T_{ch}=25^{\circ}C$		1	100	μA
		$T_{ch}=125^{\circ}C$		0.1	0.5	mA
Gate-source leakage current	I_{GSS}	$V_{GS}=\pm 30V$ $V_{DS}=0V$		10	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$I_D=25A$ $V_{GS}=10V$		20	25	mΩ
Forward transconductance	g_{fs}	$I_D=25A$ $V_{DS}=25V$	16.0	32.0		S
Input capacitance	C_{iss}	$V_{DS}=25V$		3200	4800	pF
Output capacitance	C_{oss}	$V_{GS}=0V$		760	1140	
Reverse transfer capacitance	C_{rss}	$f=1MHz$		230	345	
Turn-on time t_{on}	$t_{d(on)}$	$V_{CC}=48V$ $I_D=50A$		23	35	ns
	t_r	$V_{GS}=10V$		130	195	
Turn-off time t_{off}	$t_{d(off)}$	$R_{GS}=10\Omega$		110	165	
	t_f			65	100	
Avalanche capability	I_{AV}	$L=100\mu H$ $T_{ch}=25^{\circ}C$	50			A
Diode forward on-voltage	V_{SD}	$I_F=50A$ $V_{GS}=0V$ $T_{ch}=25^{\circ}C$		0.97	1.46	V
Reverse recovery time	t_{rr}	$I_F=50A$ $V_{GS}=0V$		150		ns
Reverse recovery charge	Q_{rr}	$-di/dt=100A/\mu s$ $T_{ch}=25^{\circ}C$		0.80		μC

● Thermal characteristics

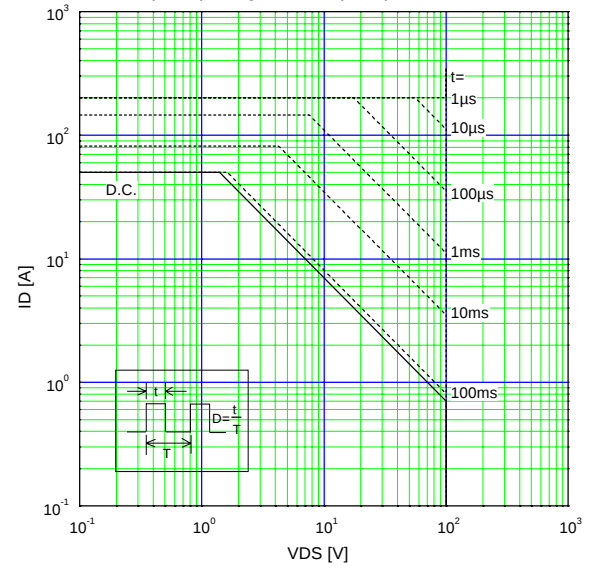
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	$R_{th(ch-c)}$	channel to case			1.79	°C/W
	$R_{th(ch-a)}$	channel to ambient			62.5	°C/W

Characteristics

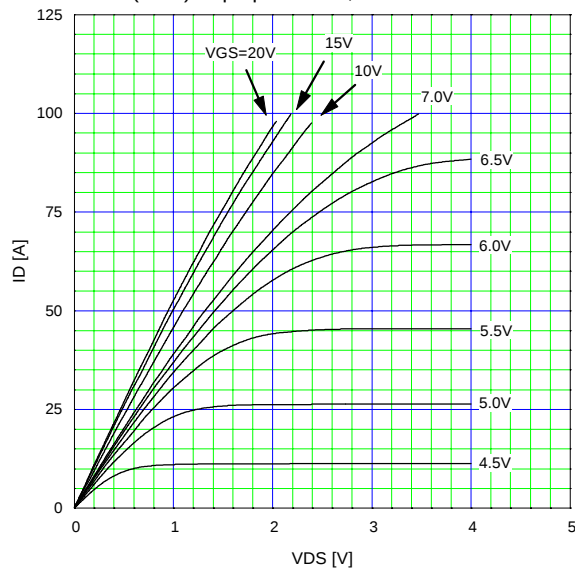
Power Dissipation
 $PD=f(T_c)$



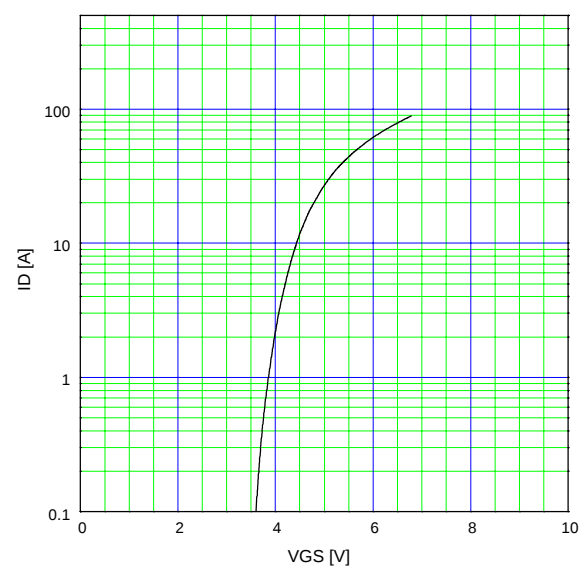
Safe operating area
 $ID=f(V_{DS}): \text{Single Pulse}(D=0), T_c=25^\circ\text{C}$



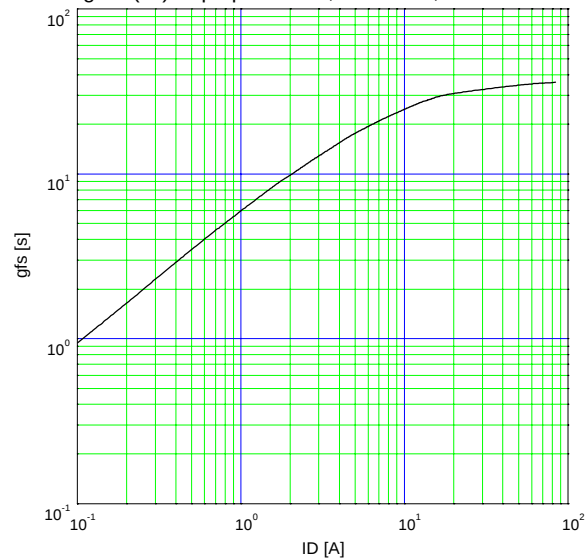
Typical output characteristics
 $ID=f(V_{DS}): 80\mu\text{s pulse test}, T_c=25^\circ\text{C}$



Typical transfer characteristics
 $ID=f(V_{GS}): 80\mu\text{s pulse test}, V_{DS}=25\text{V}, T_{ch}=25^\circ\text{C}$



Typical forward transconductance
 $g_{fs}=f(ID): 80\mu\text{s pulse test}, V_{DS}=25\text{V}, T_{ch}=25^\circ\text{C}$



Typical Drain-Source on-State Resistance
 $R_{DS(on)}=f(ID): 80\mu\text{s pulse test}, T_{ch}=25^\circ\text{C}$

